Key Features



- 50 Ohm Impedance
- 1.6 ~ 2.3 GHz
- 1.7 dB noise figure
- 48% Power Added Efficiency
- 48.0 dB Gain
- 46.0 dBm P_{sat}
- 1.22:1 VSWR
- Built-in Input Limiter
- Unconditional Stable
- Infinite Load VSWR Protection
- Over Heating Auto Shut Down
- Made IN USA

Product Description



WPA1623G is integrated with WanTcom proprietary power amplifier technology, high frequency micro electronic assembly techniques, and high reliability design to realize optimum power added efficiency, wideband, high linearity, and unconditional stable performances together in one box. With single +28V operation, the amplifier has optimal input and output matching in the specified frequency range at 50-Ohm impedance system. The amplifier has standard SMA connectorized WP-2 clear plated housing.

The amplifier is designed to meet the rugged standard of MIL-STD-202g.

Applications

- Mobile Infrastructures
- DCS, PCS, 3G WCDMA
- Fixed Wireless

Ordering Information

Model No. WPA1623G



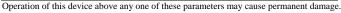
Specifications Heat sink required for continuous operation!

Summary of the electrical specifications WPA1623G at room temperature

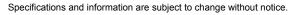
Index	Testing Item	Symbol	Test Constraints	Min	Nom	Max	Unit
1	Small Signal Gain	S ₂₁	1.6 – 2.3 GHz		48		dB
2	Gain Variation	ΔG	1.6 – 2.3 GHz		+/-1.0		dB
3	Input VSWR	SWR ₁	1.6 – 2.3 GHz		1.22:1	1.5:1	Ratio
4	Output VSWR	SWR ₂	1.6 – 2.3 GHz		1.22:1	1.5:1	Ratio
5	Reverse Isolation	S ₁₂	1.6 – 2.3 GHz		70		dB
6	Noise Figure	NF	1.6 – 2.3 GHz		1.7		dB
7	Output Saturated Power	P _{sat}	1.6 – 2.3 GHz	44	46		dBm
8	Output IP3	IP ₃	1.6 – 2.3 GHz, 37 dBm each tone, 1 MHz sep.	55	59		dBm
9	DC Power Added Efficiency	η	P _o = 40 W	44	48		%
10	Current Consumption	I _{dd}	V _{dd} = +28 V, 0.37 A quiescent DC bias			3.5	Α
11	Power Supply Voltage	V_{dd}	1.6 – 2.3 GHz	26	28	30	V
12	Base Temperature Monitoring Output	V _{to}	0.50 V at 0 °C, 10 mV per °C		10		mV/°C
13	Thermal Resistance, Junction to case	R _{th,c}	Last stage power transistor, V _{ds} =28V, Ids =0.22A			1.3	°C/W
14	Operating Temperature	To	Base plate	-20		+70	°C
15	Over Temperature Auto Shut Down	T _{shut}	Base plate threshold temperature		85		°C
16	Maximum Input CW RF Power	P _{IN, MAX}	DC – 6 GHz			30	dBm

Absolute Maximum Ratings

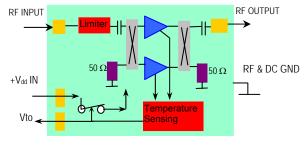
Parameters	Units	Ratings	
DC Power Supply Voltage	V	-0.5, +30	
DC Voltage Applied to V _{to}	٧	-8, +8	
DC Total Current	Α	3.5	
Total Power Dissipation (Minus RF Output Power)	W	56	
CW RF Input Power	dBm	30	
Junction Temperature	°C	220	
Storage Temperature	°C	-55 ~ 150	
Operating Temperature	°C	-20 ~ +85	
Maximum Output Load VSWR	:1	∞	
Thermal Resistance	°C/W	1.3	



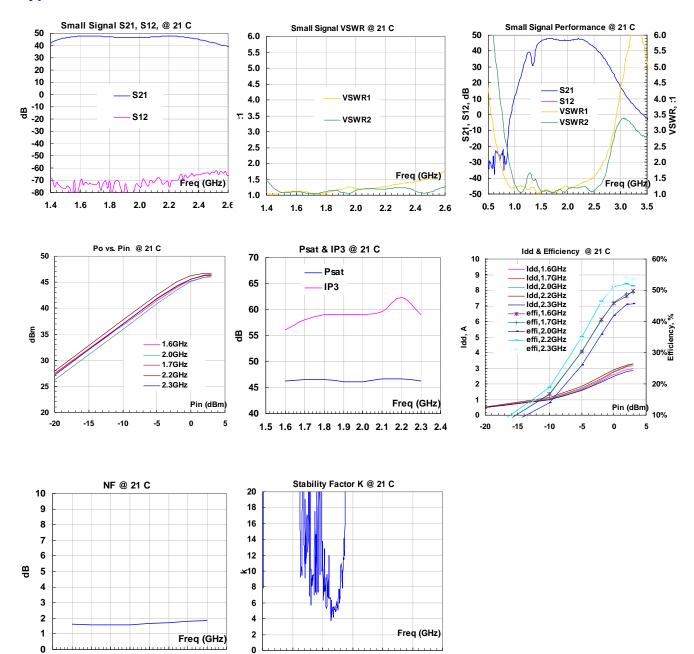
Never accidentally apply +28V on V_{to} pin! The amplifier will be permanently damaged if did.



Functional Block Diagram



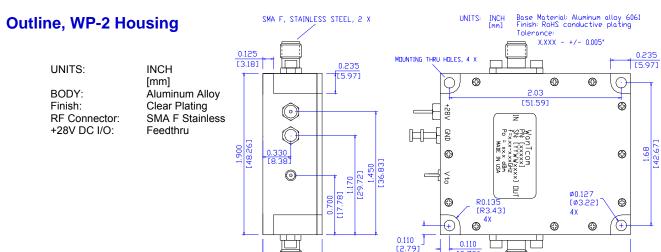
Typical Data



1.5 1.6 1.7 1.8 1.9 2.0 2.1 2.2 2.3 2.4

1.0

5.0



Application Notes:

A. Be careful of the 40 Watts output power!

Be very careful of the 40 Watts or higher output power from the amplifier! Always check the power settings to the input of the amplifier so that the output power is well below the maximum allowed power level of test equipment. Otherwise, the test equipment would be permanently damaged!

0.900 [22.86]

> 2.250 [57.15]

B. SMA Torque Wrench Selection

Always use a torque wrench with $5 \sim 6$ inch-lb coupling torque setting for mating the SMA cables to the amplifier. Never use torque more than 8 inch-lb wrench for tightening the mating cable to the connector. Otherwise, the permanent damage will occur to the SMA connectors of the amplifier. 8710-1582 (5 inch-lb) is one of the ideal torque wrench choice from Agilent Technology.

C. Mounting the Amplifier

Use four pieces of #4-40 with longer than 9/16" screws for mounting the amplifier on a metal-based chase. Flat and spring washers are needed to prevent the screw loosening during the shock and vibration. Always use the appropriate torque setting of the power screwdriver to mount them. Additional heat sink is required. A T-gon thermal film is required between the bottom of the PA and the heat sink for the effective thermal dissipation. Refer to AN-155 for heat sink design, http://wantcominc.com/engineering_tools.htm.
